

30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
30V	$5.5m\Omega$ @ $V_{GS} = 10V$	45A
	$9m\Omega @ V_{GS} = 4.5V$	30A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Power Management Functions
- DC-DC Converters
- Battery

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

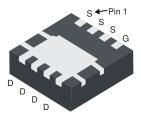
https://www.diodes.com/products/automotive/automotive-products/.

- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.
 - https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMN3009SFGQ)

Mechanical Data

- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)

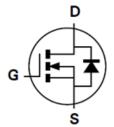
PowerDI3333-8







Top View



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3009SFG-7	PowerDI3333-8	2,000/Tape & Reel
DMN3009SFG-13	PowerDI3333-8	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- $4. For packaging details, go to our website at \ https://www.diodes.com/design/support/packaging/diodes-packaging/.$

Marking Information



N09= Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 21 = 2021) WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V _{DSS}	30	V	
Gate-Source Voltage	V _{GSS}	±20	V	
	T _A = +25°C	I _D	16	А
	$T_A = +70^{\circ}C$		13	
Continuous Drain Current, V _{GS} = 10V (Note 6)	T _C = +25°C	- I _D	45	Α
	Tc = +70°C		35	
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	IDM	80	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	20	Α	
Avalanche Current, L = 0.1mH	las	33	Α	
Avalanche Energy, L = 0.1mH	Eas	55	mJ	

Thermal Characteristics

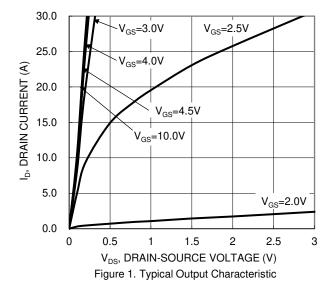
Characteristic		Symbol	Value	Unit	
Total Dawar Dissipation (Note 5)	T _A = +25°C	Pn	0.9	144	
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.6	W	
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	137	°C/W		
Total Dawar Dissipation (Note 6)	T _A = +25°C	Pn	2.1	W	
Total Power Dissipation (Note 6)	T _A = +70°C	FU	1.4	VV	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	59	°C/W	
Thermal Resistance, Junction to Case (Note 6)	R ₀ JC	7.8	°C/W		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	VGS = 0V, ID = 250µA	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 24V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(TH)}	1	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	Daggara		3.4	5.5	mΩ	VGS = 10V, ID = 20A	
Static Drain-Source On-nesistance	RDS(ON)	_	4.4	9	11122	$V_{GS} = 4.5V, I_{D} = 16A$	
Diode Forward Voltage	V_{SD}	_	0.7	1	V	$V_{GS} = 0V$, $I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss	_	2,000	_	pF		
Output Capacitance	Coss	_	315	_	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1MHz	
Reverse Transfer Capacitance	Crss	_	248	_	pF	1 – 1101112	
Gate Resistance	R_g	_	2.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (VGS = 4.5V)	Qg	_	20	_	nC		
Total Gate Charge (VGS = 10V)	Qg	_	42	_	nC	V _{DS} = 15V, I _D = 15A	
Gate-Source Charge	Qgs		4.7	_	nC	VDS = 15V, ID = 15A	
Gate-Drain Charge	Q_{gd}	_	7.4	_	nC	1	
Turn-On Delay Time	t _{D(ON)}	_	3.9	_	ns		
Turn-On Rise Time	tr	_	4.1	_	ns	$V_{DD} = 15V, V_{GS} = 10V,$	
Turn-Off Delay Time	tD(OFF)	_	31	_	ns	$R_G = 3.3\Omega$, $I_D = 15A$	
Turn-Off Fall Time	tF	_	14.6	_	ns		
Reverse Recovery Time	t _{RR}	_	15	_	ns	I_ 15A di/dt 100A/us	
Reverse Recovery Charge	Qrr	_	6	_	nC	I _F = 15A, di/dt = 100A/µs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect. Notes:





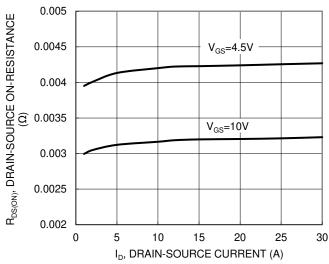


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

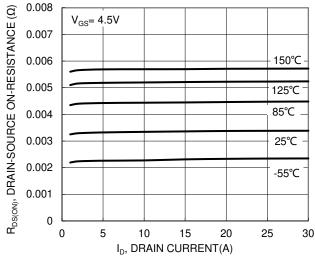


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

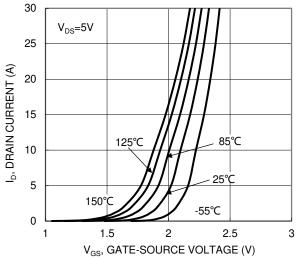
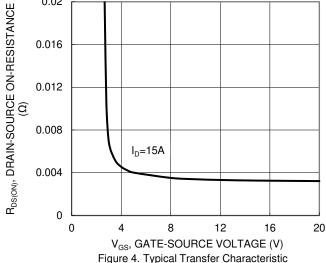


Figure 2. Typical Transfer Characteristic

0.02



1.8 R_{DS(ON)}, DRAIN-SOURCE ON-RESISTANCE (NORMALIZED) $V_{GS}=10V, I_D=30A$ 1.6 1.4 1.2 $V_{GS} = 4.5V, I_{D} = 15A$ 1 8.0 0.6 -25 25 50 0 75 100 125 150 -50 T_J , JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with Temperature

DMN3009SFG



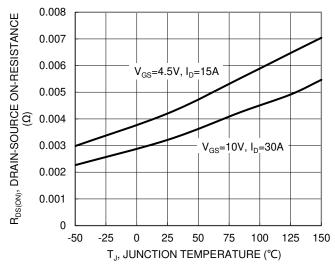
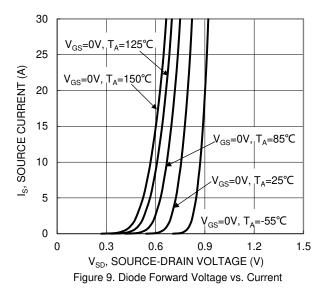
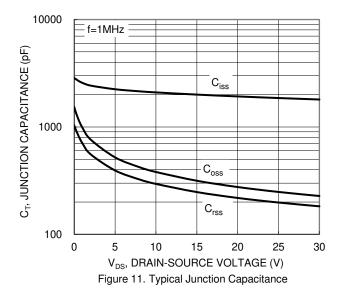


Figure 7. On-Resistance Variation with Temperature





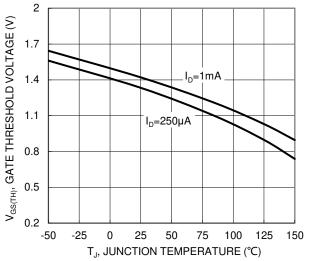


Figure 8. Gate Threshold Variation vs. Junction Temperature

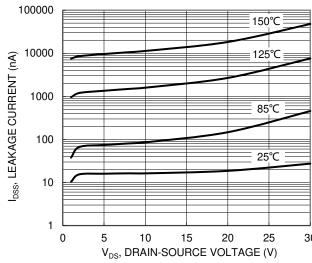
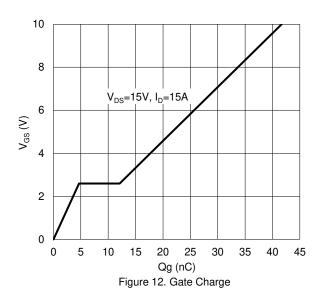
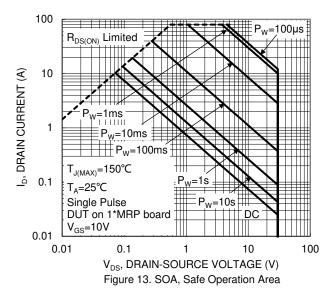


Figure 10. Typical Drain-Source Leakage Current vs. Voltage







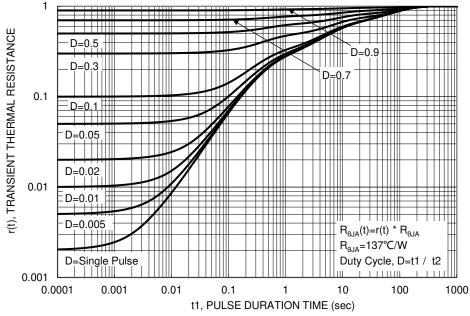


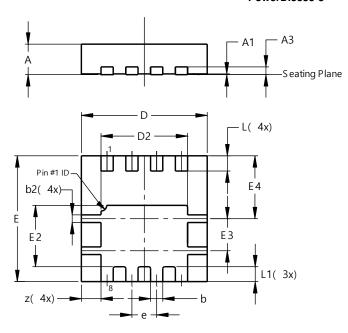
Figure 14. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

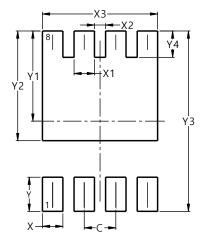


PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A 1	0.00	0.05	0.02		
A3			0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
Е	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
е		_	0.65		
L	0.35	0.45	0.40		
L1	_		0.39		
Z	_	_	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)		
С	0.650		
Х	0.420		
X1	0.420		
X2	0.230		
Х3	2.370		
Υ	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		
Y4	0.540		



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